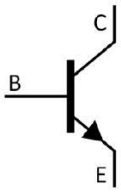
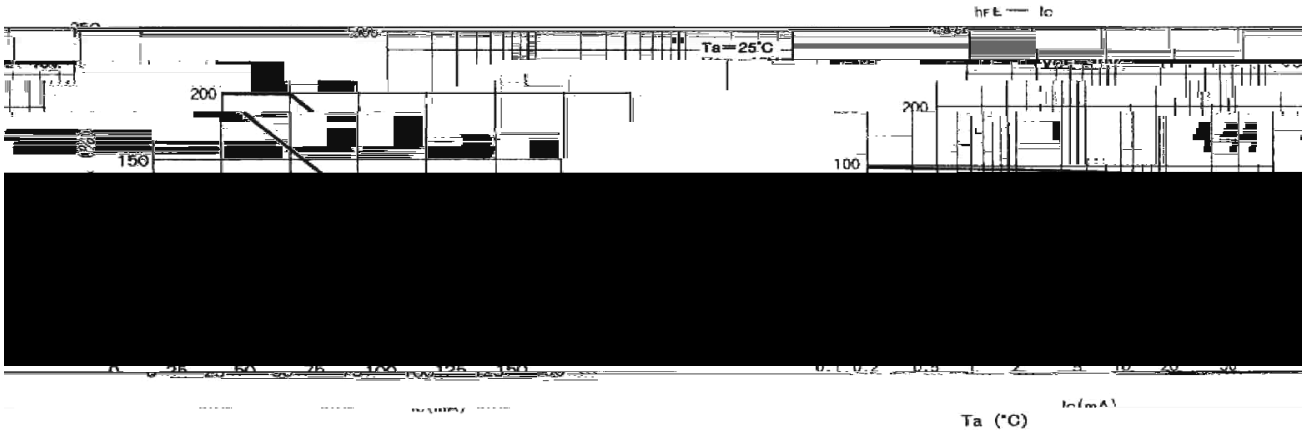
SOT-23 NPN

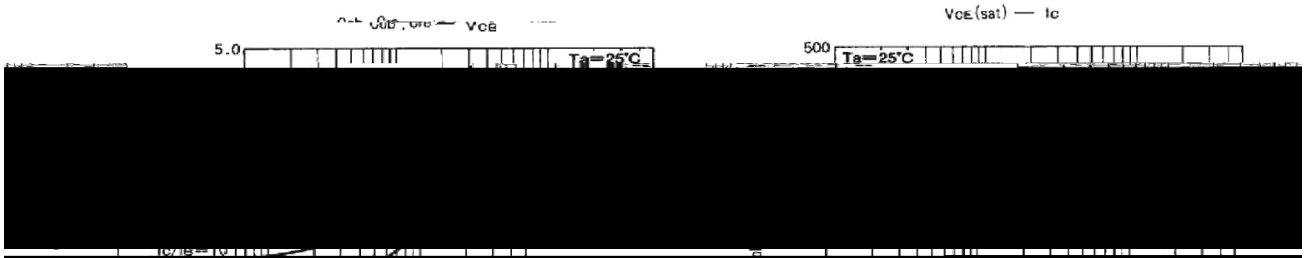
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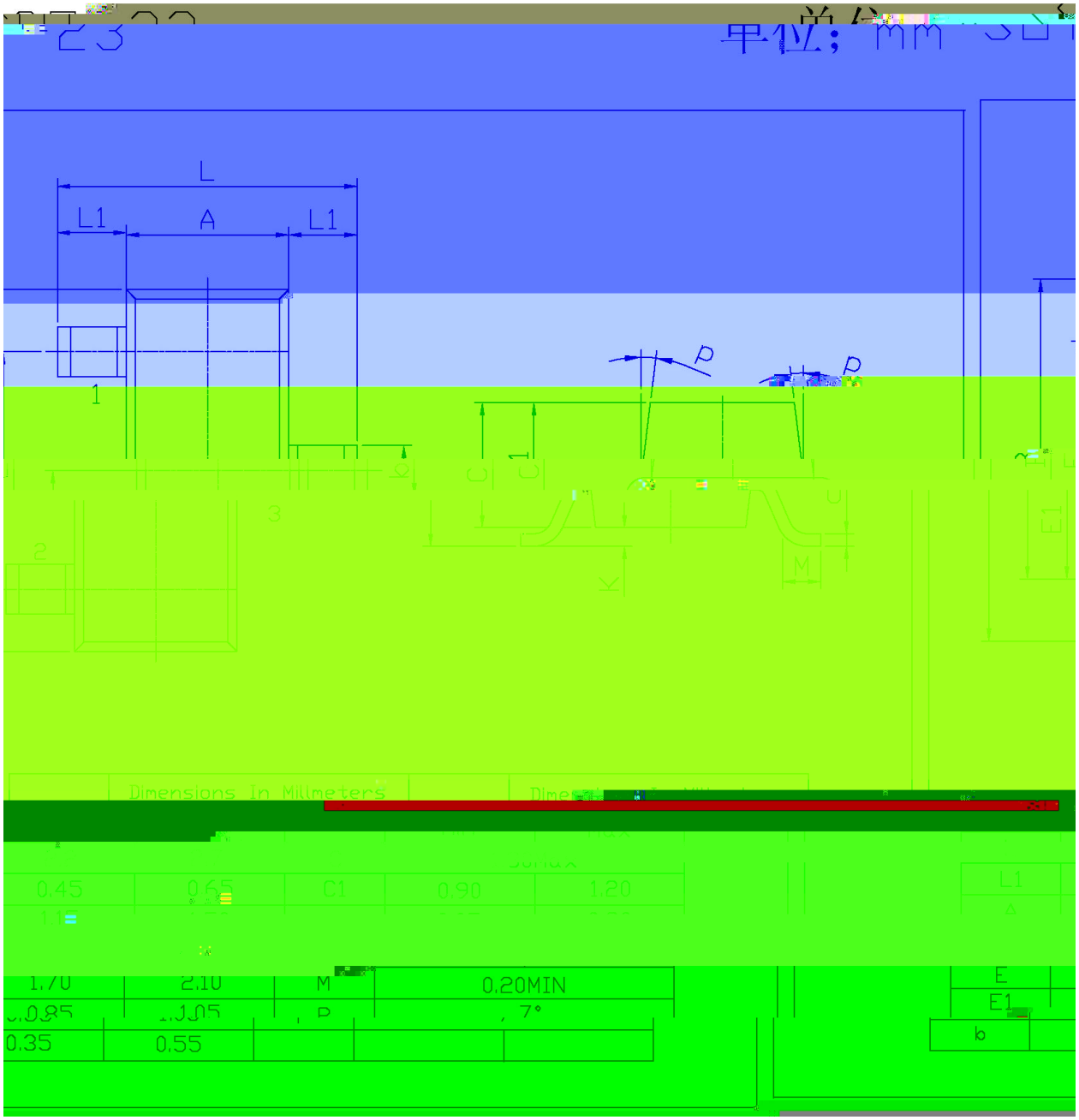


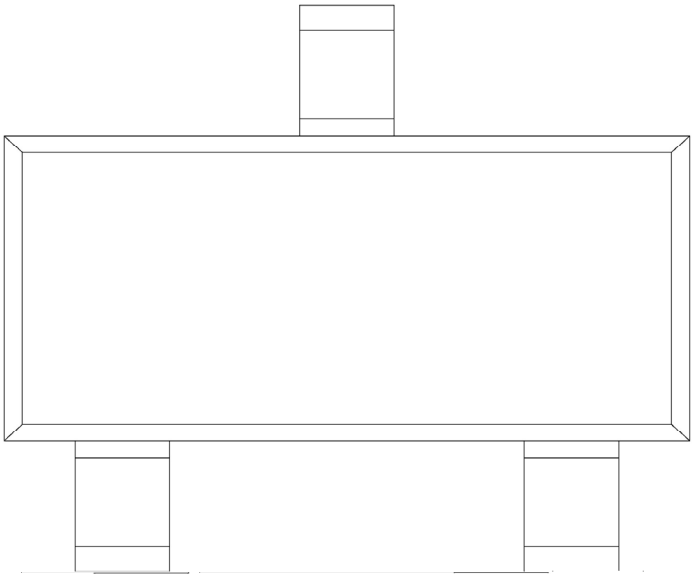
		μ				
		μ				
						μ
						μ
		Ω				


Ta=25°C
200
150
100
Ta (°C)

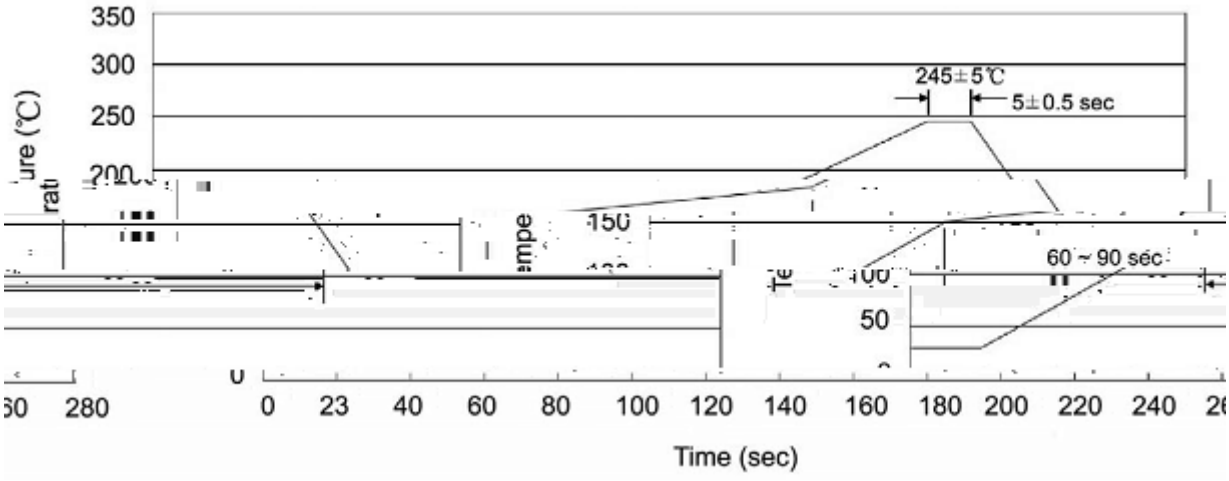

5.0
Ta=25°C
500
Ta=25°C


0.2
2.0
Ta=25°C
VCE=10V


单位：mm
L
L1
A
L1
Dimensions In Millmeters
0.45
0.65
C1
0.90
1.20
1.70
2.10
M
0.20MIN
0.35
0.55
E
E1
b



Temperature Profile for IR Reflow Soldering(Pb-Free)



± ± ± ±

封装形式	包装数量					包装尺寸 :		
	Units/Reel 只/卷盘	Reels/Inner Box 卷盘/盒	Units/Inner Box 只/盒	Inner Boxes/Outer Box 盒/箱	Units/Outer Box 只/箱	Reel	Inner Box 盒	Outer Box 箱
SOT-23	3,000	10	30,000	6	180,000	7 ×8	180×120×180	390×385×205